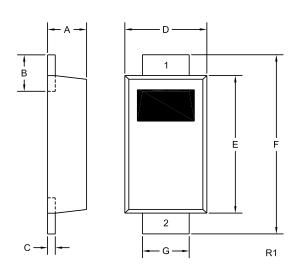
SURFACE MOUNT SILICON SCHOTTKY RECTIFIERS 1.0 AMP, 20 THRU 100 VOLT



# $\textbf{ELECTRICAL CHARACTERISTICS - Continued:} \ (T_A = 25 ^{\circ}\text{C unless otherwise noted})$

SYMBOL	TEST CONDITIONS	TYP	UNITS
CJ	V <sub>R</sub> =4.0V, f=1.0MHz (CMMSH1-20, -20G)	60	pF
$C_J$	V <sub>R</sub> =4.0V, f=1.0MHz (CMMSH1-40, -40G)	60	pF
CJ	V <sub>R</sub> =4.0V, f=1.0MHz (CMMSH1-60, -60G)	50	pF
CJ	V <sub>R</sub> =4.0V, f=1.0MHz (CMMSH1-100, -100G)	40	pF

### **SOD-123F CASE - MECHANICAL OUTLINE**



DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.035	0.043	0.88	1.08			
В	0.020	0.031	0.50	0.80			
С	0.004	0.008	0.10	0.20			
D	0.065	0.077	1.65	1.95			
E	0.104	0.116	2.65	2.95			
F	0.140	0.156	3.55	3.95			
G	0.030	0.041	0.75	1.05			

SOD-123F (REV:R1)

# LEAD CODE:

- 1) Cathode
- 2) Anode

# MARKING CODES:

DEVICE	CODE
CMMSH1-20	CS20F
CMMSH1-40	CS40F
CMMSH1-60	CS60F
CMMSH1-100	CS100F
CMMSH1-20G*	CS20G
CMMSH1-40G*	CS40G
CMMSH1-60G*	CS60G
CMMSH1-100G*	CS100G

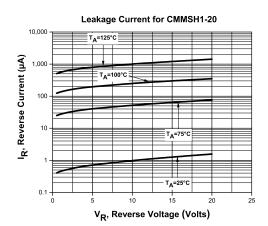
<sup>\*</sup> Device is *Halogen Free* by design

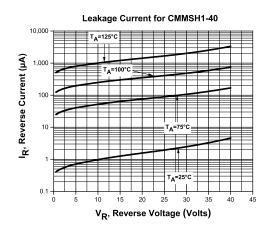
R6 (23-November 2015)

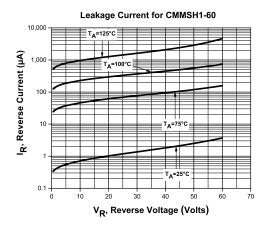
SURFACE MOUNT SILICON SCHOTTKY RECTIFIERS 1.0 AMP, 20 THRU 100 VOLT

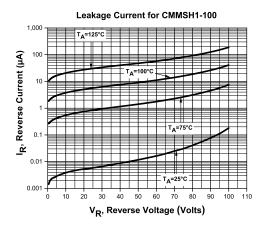


#### TYPICAL ELECTRICAL CHARACTERISTICS







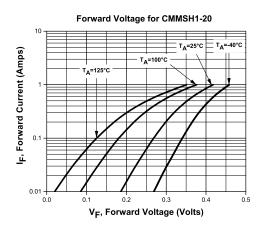


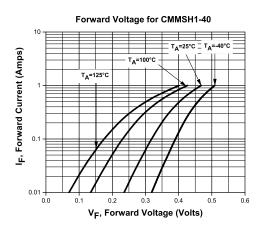
R6 (23-November 2015)

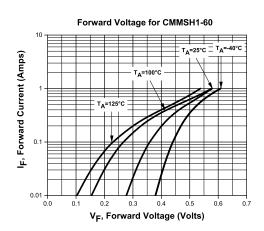
SURFACE MOUNT SILICON SCHOTTKY RECTIFIERS 1.0 AMP, 20 THRU 100 VOLT

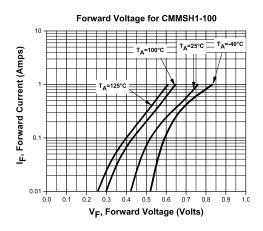


#### TYPICAL ELECTRICAL CHARACTERISTICS







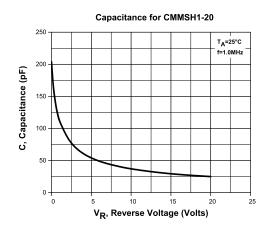


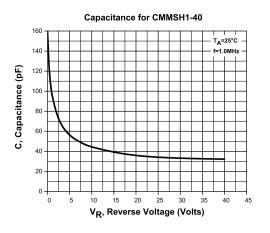
R6 (23-November 2015)

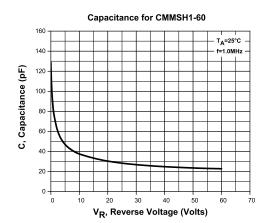
SURFACE MOUNT SILICON SCHOTTKY RECTIFIERS 1.0 AMP, 20 THRU 100 VOLT

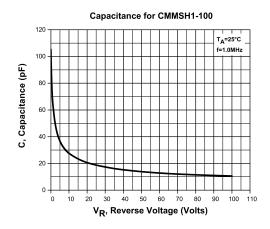


#### TYPICAL ELECTRICAL CHARACTERISTICS









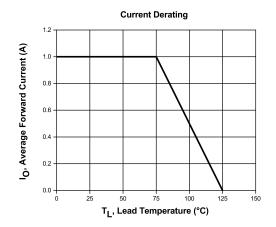
R6 (23-November 2015)

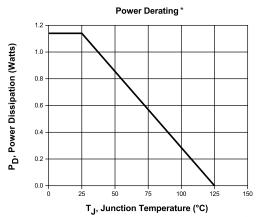
SURFACE MOUNT SILICON SCHOTTKY RECTIFIERS

1.0 AMP, 20 THRU 100 VOLT



#### TYPICAL ELECTRICAL CHARACTERISTICS





\*FR-4 Epoxy PC Board with Copper Mounting Pad Area of 2.9mm<sup>2</sup>

R6 (23-November 2015)



## **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**

#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2<sup>nd</sup> day air)
- · Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- · PbSn plating options
- · Package details
- · Application notes
- · Application and design sample kits
- Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

## **CONTACT US**

#### Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA Main Tel: (631) 435-1110 Main Fax: (631) 435-1824

Support Team Fax: (631) 435-3388

www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

**Worldwide Distributors:** 

www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: <a href="https://www.centralsemi.com/terms">www.centralsemi.com/terms</a>

www.centralsemi.com (001)